

ROHS COMPLIANT

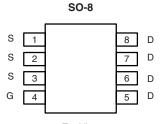
HALOGEN

FREE Available

Vishay Siliconix

N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)		
30	0.0094 at V _{GS} = 10 V	16	14 nC		
	0.0115 at V _{GS} = 4.5 V	14	14110		



Top View

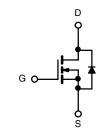
Ordering Information: Si4684DY-T1-E3 (Lead (Pb)-free) Si4684DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- Extremely Low Q_{gd} WFET[®] Technology for Low Switching Losses
- TrenchFET[®] Power MOSFET
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- High-Side DC/DC Conversion
- Notebook - Server



N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	S T _A = 25 °C, unles	ss otherwise not	ed		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V _{GS}	± 12		
	T _C = 25 °C		16		
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C	1-	12.9		
Continuous Drain Current $(T_j = 150 \text{ C})$	T _A = 25 °C	I _D	12 ^{b, c}		
	T _A = 70 °C		9.5 ^{b, c}	٨	
Pulsed Drain Current		I _{DM}	50	A	
Continuous Source-Drain Diode Current	T _C = 25 °C	1-	4.0		
	T _A = 25 °C	I _S	2.3 ^{b, c}		
Single Pulse Avalanche Current		I _{AS}	20		
Avalanche Energy L = 0.1 mH		E _{AS}	20	mJ	
	T _C = 25 °C		4.45		
Maximum Power Dissipation	T _C = 70 °C	PD	2.85	w	
	T _A = 25 °C	' D	2.50 ^{b, c}	VV	
	T _A = 70 °C		1.6 ^{b, c}		
Operating Junction and Storage Temperature R	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	36	50	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	22	28	

Notes:

a. Based on T_C = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board. c. t = 10 s.

d. Maximum under Steady State conditions is 90 °C/W.

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Parameter	Symbol	erwise noted Test Conditions	Min.	Тур.	Max.	Unit	
Static	Cynisor			.,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	maxi	•	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$			30		mV/°C	
V _{GS(th)} Temperature Coefficient	ΔV _{GS(th)} /T _J	I _D = 250 μA		4.5			
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	0.6		1.5		
		$V_{DS} = V_{GS}, I_D = 5 \text{ mA}$		1.1		V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 100	nA	
	I _{DSS}	$V_{DS} = 30 V, V_{GS} = 0 V$			1	μΑ	
Zero Gate Voltage Drain Current		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	30			Α	
		V _{GS} = 10 V, I _D = 16 A		0.0078	0.0094	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 9.5 \text{ A}$		0.0092	0.0115		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 16 A		45		S	
Dynamic ^b	I			1	1		
Input Capacitance	C _{iss}	Ciss		2080			
Output Capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		340		pF	
Reverse Transfer Capacitance	C _{rss}			135			
Total Gate Charge	Q _g Q _{gs} Q _{gd}	V _{DS} = 15 V, V _{GS} = 10 V, I _D = 11 A		30	45	nC	
				14	21		
Gate-Source Charge		V _{DS} = 15 V, V _{GS} = 4.5 V, I _D = 11 A		3			
Gate-Drain Charge				2.8			
Gate Resistance	Rg	f = 1 MHz	0.2	0.55	0.9	Ω	
Turn-On Delay Time	t _{d(on)}			15	25		
Rise Time	t _r	V_{DD} = 15 V, R _L = 1.87 Ω		60	100	I	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ 8 A, V_{GEN} = 4.5 V, R_g = 1 Ω		28	45		
Fall Time	t _f			9	15		
Turn-On Delay Time	t _{d(on)}			12	20	ns	
Rise Time	t _r	V_{DD} = 15 V, R_L = 1.87 Ω		12	20		
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D} \cong$ 8 A, V_GEN = 10 V, R_g = 1 Ω		45	70		
Fall Time	t _f			11	18		
Drain-Source Body Diode Characteris	tics				1		
Continuous Source-Drain Diode Current	ا _S	T _C = 25 °C			4	۸	
Pulse Diode Forward Current ^a	I _{SM}				50	A	
Body Diode Voltage	V _{SD}	I _S = 2.3 A		0.70	1.1	V	
Body Diode Reverse Recovery Time	t _{rr}			30	45	ns	
Body Diode Reverse Recovery Charge				26	40	nC	
Reverse Recovery Fall Time	t _a	· I _F = 9.5 A, dl/dt = 100 A/μs, T _J = 25 °C		16			
Reverse Recovery Rise Time	t _b	1 1		14		ns	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

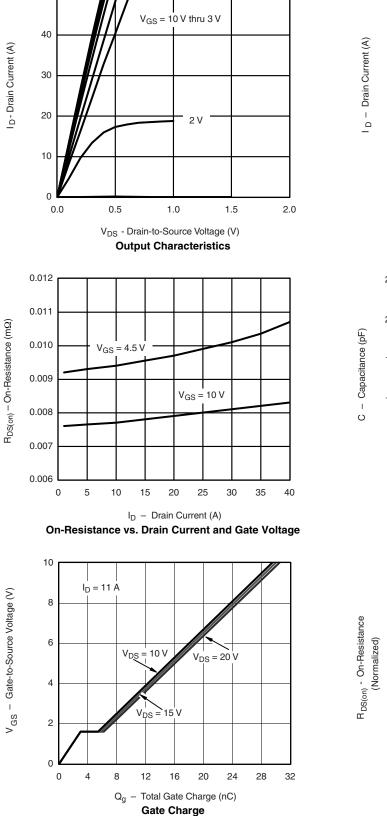


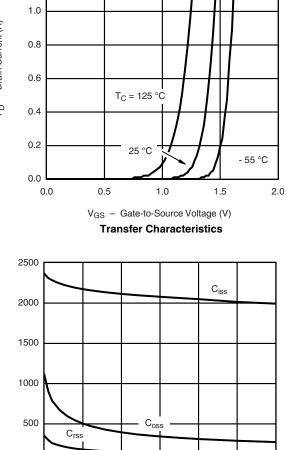
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Si4684DY

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





1.2

0

0

5

V_{DS} - Drain-to-Source Voltage (V) Capacitance

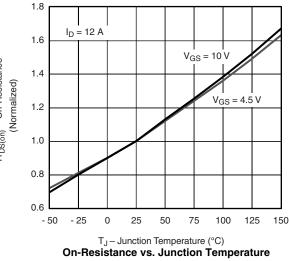
15

20

25

30

10

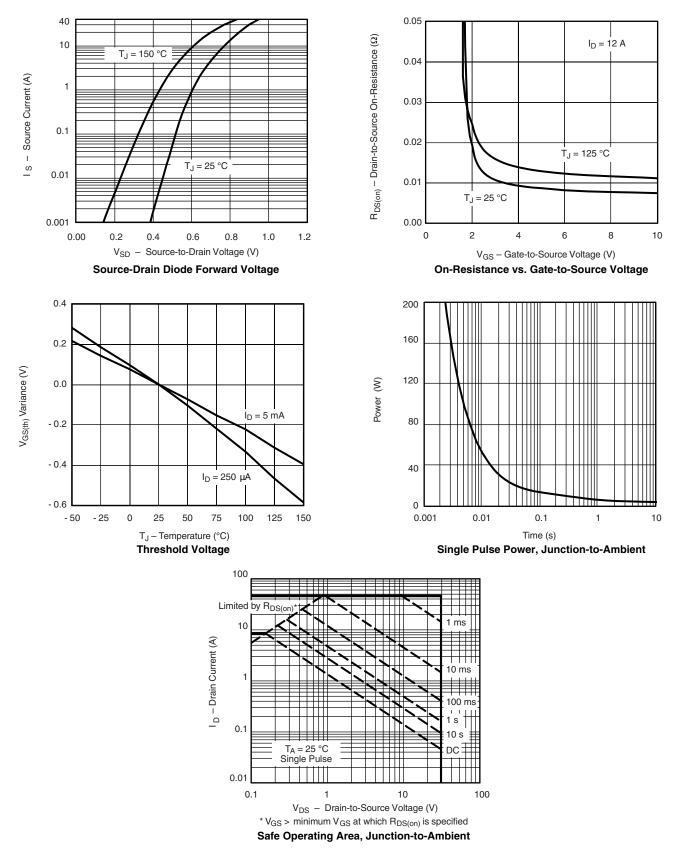


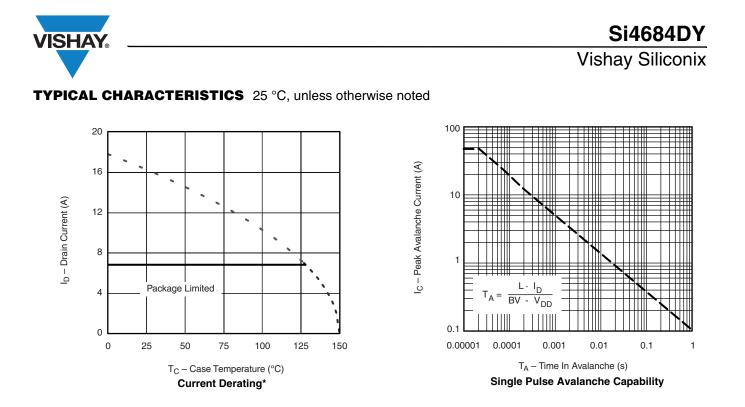
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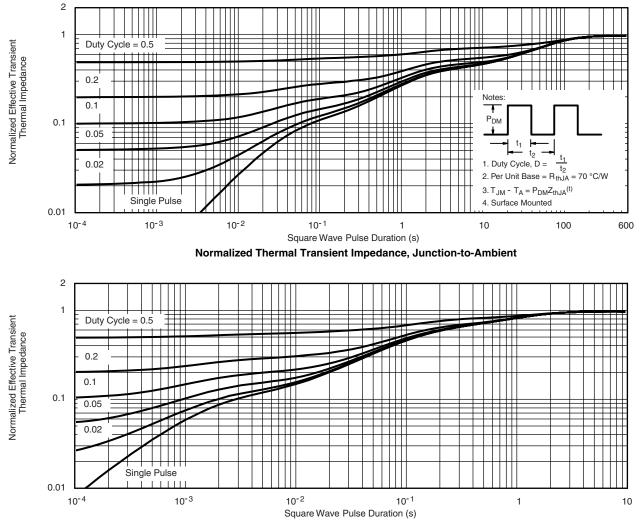


* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?73324.



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